

B. Sc. Part – II CBCS Syllabus
DSC -1005 C Semester: III Electronics-Paper- III
Electronics Communication and Microprocessor
8085

Section II: Microprocessor 8085

UNIT 1: Microcomputer Organization

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Syllabus

Unit 1: Microcomputer Organization:

Basic components of microcomputer(CPU, Program memory, Data memory, input and output ports, idea of RAM (SDRAM,DRAM) Types of ROM Memory organization & addressing. Memory Interfacing, Memory Map.

Chapter –I

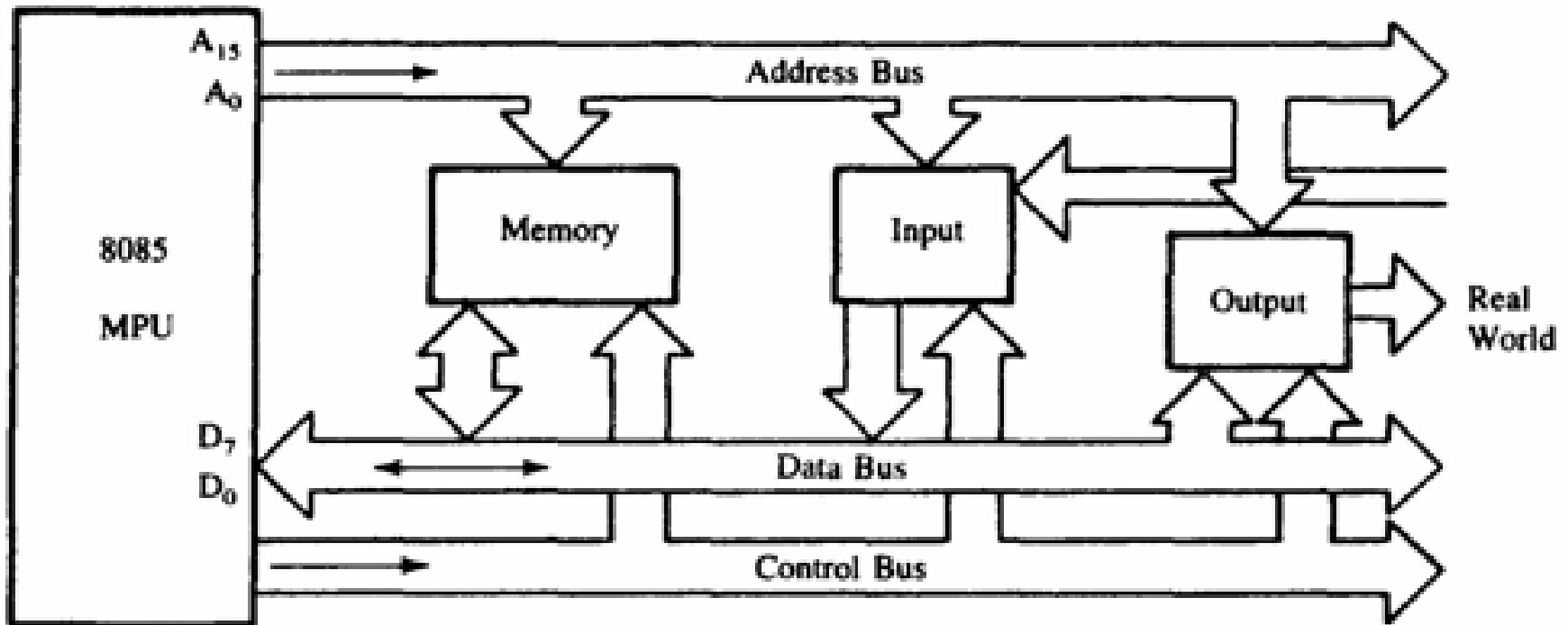
Microcomputer Organization

1.1 Introduction:

- Microcomputer: It is a small, relatively inexpensive Computer with a microprocessor as its Central Processing Unit (CPU). It includes a microprocessor, memory, and minimal input/output (I/O) circuitry mounted on a single Printed Circuit Board (PCB).
- Microcomputer is designed for individual use and is smaller in size than a mainframe or a minicomputer.
- Microcomputers can be referred as, simply, computers, or personal computers (PC). Desktop computers, laptops, personal digital assistant (PDA), tablets & Smart-phones are all types of microcomputers.

1.2 Organization of Microcomputer:-

- i) Microprocessor ii) Memory iii) Input unit iv) Output unit



➤ 1.2.1 Microprocessor:

Microprocessor is a multipurpose, programmable logical device that reads binary instructions from memory, accepts binary data as an input & processes the data according to those instructions and provides the result as an output.

Microprocessor has 3 minimum components:

- a) ALU [Arithmetic Logical Unit]:-In this area of microprocessor, various computing functions are performed on data. It performs arithmetic operations as well as logical operations.
- b) Register Array:-It consists of various registers. These registers are primary used to store the data temporarily during the execution of the program.
- c) Control unit [CU]: - provides the necessary timing & control signals to all the operations in the microprocessor system.

1.2.1.1 Evolution of the Microprocessors:

1st Generation: (1971 to 1973)

The first μP was introduced in 1971 by Intel (Integrated Electronics) Corporation. This was the Intel 4004, a processor on a single chip. It had the capability of performing simple arithmetic and logical operations. For example, addition, subtraction, comparison, logical AND and OR operations. It also had a control unit which could perform various control functions like fetching an instruction from the memory, decoding it and generating control signals to execute it.

During this period, the other microprocessors were launched in the market such as Rockwell international PPS-4, INTEL-8008 and National semiconductors IMP-16. INTEL-8008 was the first 8 bit μP , which would perform arithmetic and logic operations on 8 bit words, was introduced in 1973, by Intel. Then its improved version- INTEL 8080 was introduced.

The First generation microprocessors were designed using the PMOS (P-channel Metal Oxide Semiconductor) technology. This technology was cost effective, but with slow device speed, low output currents and compatible only with TTL family.

2nd Generation: (1973 to 1978)

very efficient 8-bit microprocessors were implemented like INTEL-8085, Motorola 6800 and 6801 and Zilogs-Z80, which were among the most popular ones. Owing to their superfast speed, they were costly as they were based on **NMOS (N-channel MOS)** technology [fabrication](#).

3rd Generation: (1979 to 1980)

During this period 16 bit processors were designed using **HMOS(High-performance n-channel Metal Oxide Semiconductor)** technology. From 1979 to 1980, INTEL 8086/80186/80286 and Motorola 68000 and 68010 were introduced.

Speeds of those processors were four times better than the 2nd generation processors.

Later, Intel introduced a high speed version of the 8085A called 8085AH using HMOS technology. One of the most popular 16-bit μ P introduced by Intel was 8088. The 8088 has the same instruction set as the 8086. However, it has only an 8 bit data bus. The **8088 was the μ P used in the IBM PC** and its clones.

4th Generation: (1981 to 1995)

developed 32 bit microprocessors by using HCMOS (High-performance Complementary Metal Oxide Semiconductor) fabrication. INTEL-80386/80486, Motorola's 68020/68030/68040 and National semiconductor NS 32032 were the popular processors. These microprocessors have on-chip RAM called the **cache memory** to speed up program execution.

5th Generation: From 1995 to until now

high-performance and high-speed processors that make use of 64-bit processors. Such processors include Pentium, Celeron, Dual and Quad core , i3,15,17 processors.

Table 1.1: Evaluation of major μ P characteristics from Intel

	4004	8008	8085A	8086	80386
Year of Introduction	1971	1971	1977	1978	1985
Data Bus	4-bit	8-bit	8-bit	16-bit	32-bit
Technology	PMOS	PMOS	NMOS	HMOS	CHMOS
Word size data/ instr.	4/8	8/8	8/8	16/16	32/32
Address capacity	4K	16K	64K	1M	4G
Clock kHz/phase	740/2	800/2	6250/2	8000/2	16000/2
Addition time	10.8 μ s	20 μ s	1.3 μ s	0.375 μ s	0.125 μ s
ALU/General Purpose Reg.	1/16	1/6	1/6	1/8	1/8
Stack size	3x12	7x14	RWM	RWM	RWM
Voltages	15-10,5*	-9.5v	+5V	+5V	+5V
Package size	16pin	18pin	40pin	40pin	132pin
Instructions	45	48	74	133	135
Transistors	2,300	2,000	6,200	29,000	2,75,000
Chip size(mil)	117x159	125x170	164x222	225x230	390x390

1.2.1.2 Applications of Microprocessors:

It is used in two different ways.

1. **as a programmable logic device** to control the process.

e. g -in home appliances, wireless communication equipments, office publication and automation, consumer electronics, calculators, accounting system, video games, industrial controllers and data acquisition systems.

2. **as a data processing unit or a computing units** of a computer like Desktop computers, laptops.

1.2.2Memory: -

to store program/ instructions and data.

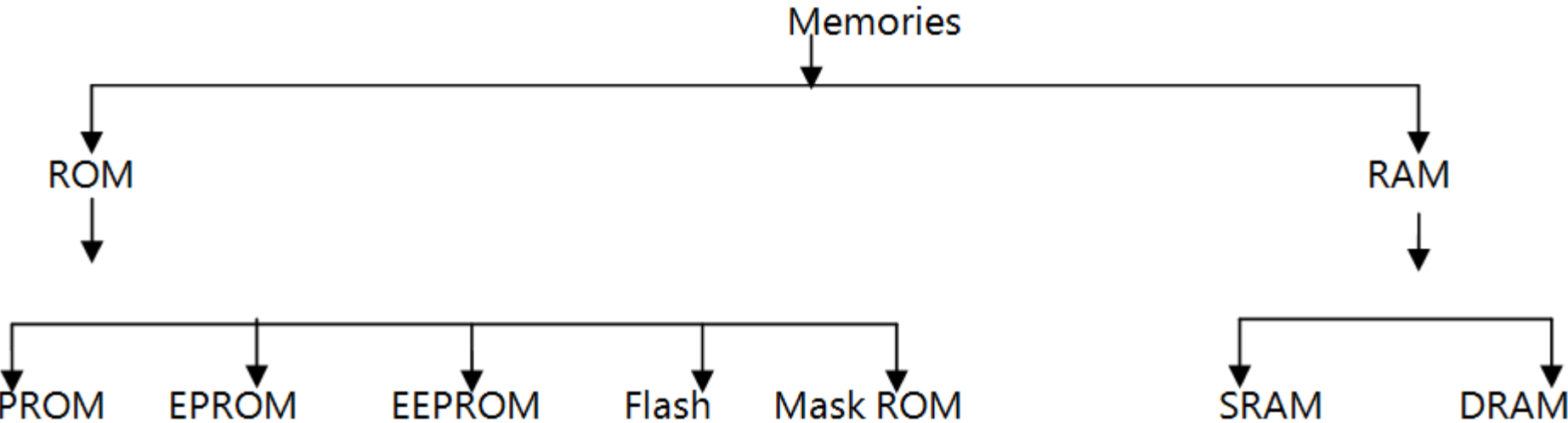
The semiconductor memories are of two types ROM and RAM.

ROM is a non-Volatile memory while **RAM is Volatile** memory.

To store program/instructions, the system should have permanent (non-Volatile) memory, because program should not get erased due to any reason. It should remain intact even if power supply is switched off. Such a memory is called as “**Program Memory**”. Its examples are **EPROM or Flash** memories. Now- a- days flash memories are most widely used.

Also system should require another type of memory to store data temporarily. So once data is used, it can be over written by new data. Thus we use this memory as “**scratch pad**”. Such a memory is also called as “**Data Memory**”. Its examples are **SRAM (Static RAM) and DRAM (Dynamic RAM)**.

Fig. 1.2 Types of semiconductor Memories



1.2.2.1ROM (Read-only memory): ROM is a type of memory that does not lose its contents when the power is turned off, hence ROM is called *nonvolatile memory*. There are different types of read- only memory. They are PROM, EPROM, EEPROM, flash and masked ROM.

PROM (Programmable Read only Memory):In a PROM for every bit there exist a fuse. PROM is programmed by blowing the fuses. Once the fuses are burned we can't change data hence PROM is some time known as OTP (One time programmable)

EPROM(Erasable Programmable Read only Memory) :

Widely used EPROM is UV-EPROM i.e. **Ultra-Violet Erasable Programmable Read Only Memory**. This memory IC have a quartz window on it. When this IC is exposed with ultra violet light through this window for about 15 to 20 minutes then all the contents of this memory are erased. Upon erasing it can be reprogrammed by using EPROM programmer. Such ICs has a part number 27XX. e.g. 27128 where 27 refers UV-EPROM with capacity 128 K bits or 16 K bytes. The program/erase cycle for EPROM is 1,000 times.

Disadvantages : 1) It can't be programmed when it is in system board.

2) Single bit or byte can't be erased.

EEPROM or E²PROM: (Electrically Erasable Programmable Read

Only Memory): This is similar to EPROM except that the erasing is done by electrical signals instead of UV light. Advantage of EEPROM is it can be erased and reprogrammed without removing it from board. Its single location can be erased. The program/erase cycle for EPROM is 1,00,000 times.

Flash EPROM: Now a days this is most popular Erasable Programmable ROM. It is widely used in mobile card, camera, even hard disk of computer. It is similar to EEPROM, but with small electrical pulse or flash (less than 1 sec.) all contents of memory are erased. This memory can be reprogrammed while it is in its socket. The program/erase cycle for flash is 1,00,000 times.

Mask ROM: Contents or data on this ROM is programmed by IC manufacturer; hence it is not user-programmable ROM. It is costly and used only when large quantity is required.

1.2.2.2 RAM (Random access Memory):

RAM is type of memory that loses its contents when power is turned off, hence RAM is called *volatile memory*; sometimes it is also called as Read-write memory. There are two types of RAMs, 1) SRAM and 2) DRAM.

SRAM (Static RAM): In this type of memory 1 or 0 are stored on memory cell in the form of voltage. Memory cell is constructed using flip-flop and each flip-flop requires about 6 transistors, so such memories are bulky.

DRAM(Dynamic RAM):

In this type of memory, data (i.e.1 and 0) is stored in the form of charge on capacitor instead of voltage. Because of this number of transistors required to store data are reduced as compare to static RAM. Due to this size of memory cell is also reduced. However this type of memory requires constant refreshing due to leakage of charge on capacitor.

1.2.2.3 Memory structure and its requirements:

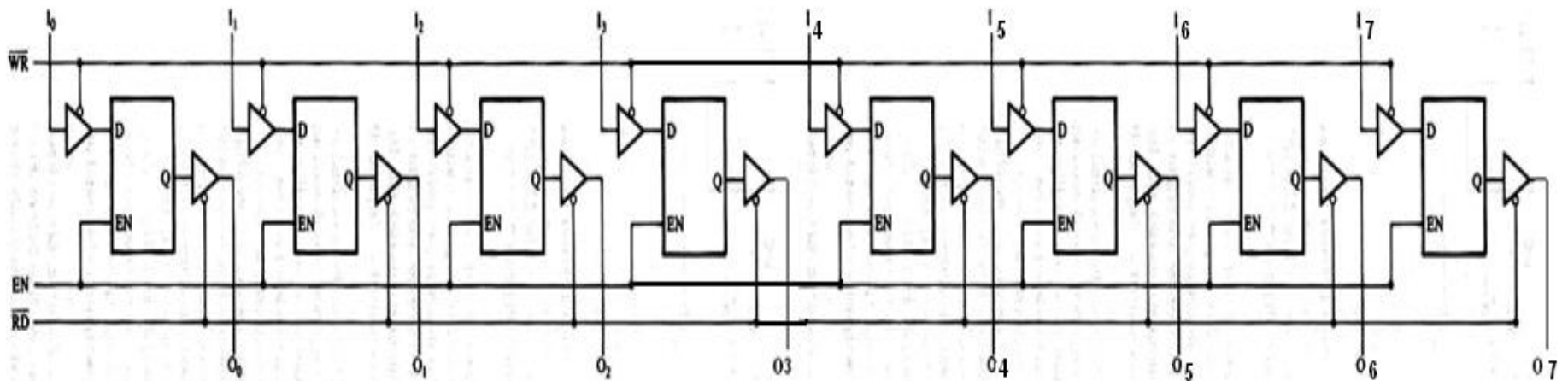
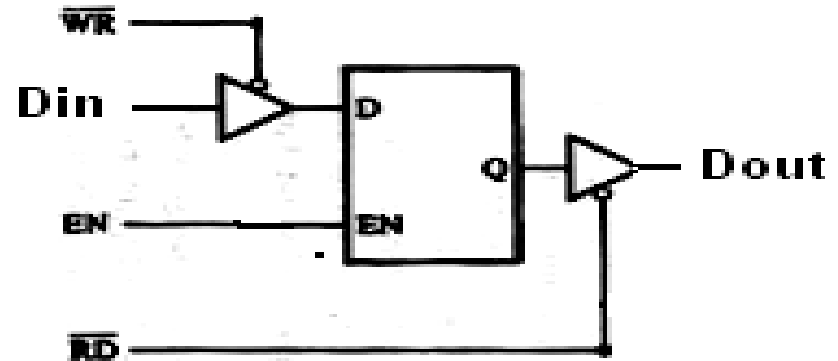
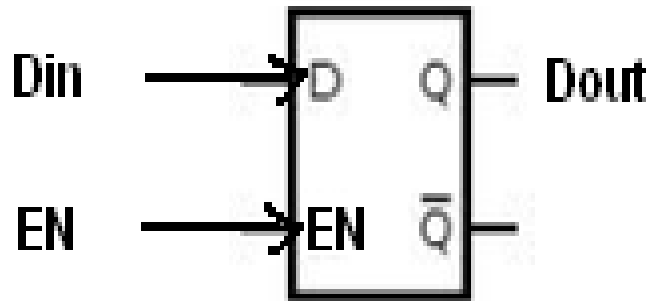
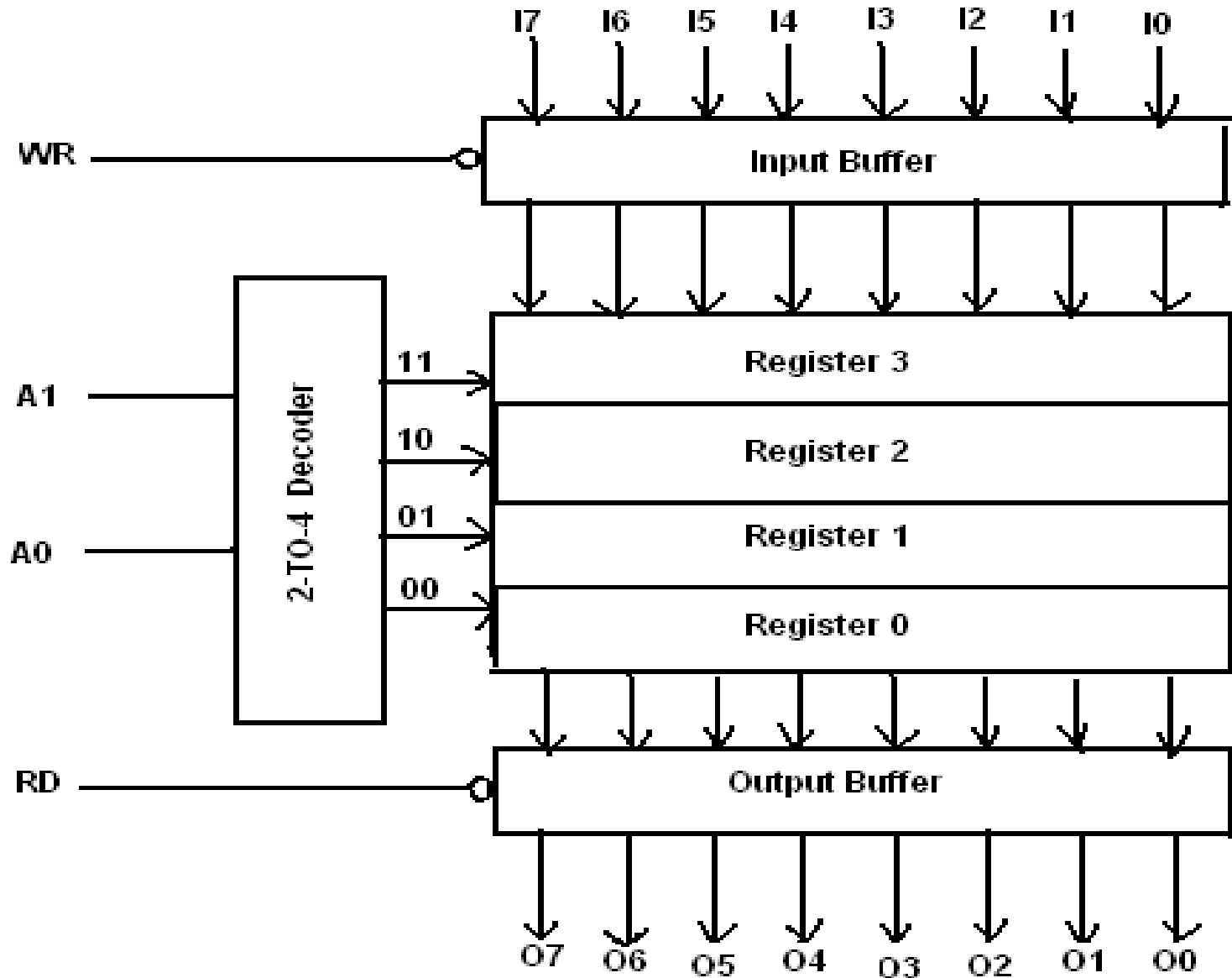


Fig. 1.5 : 4 × 8-bit register



Pin connections to memory devices:

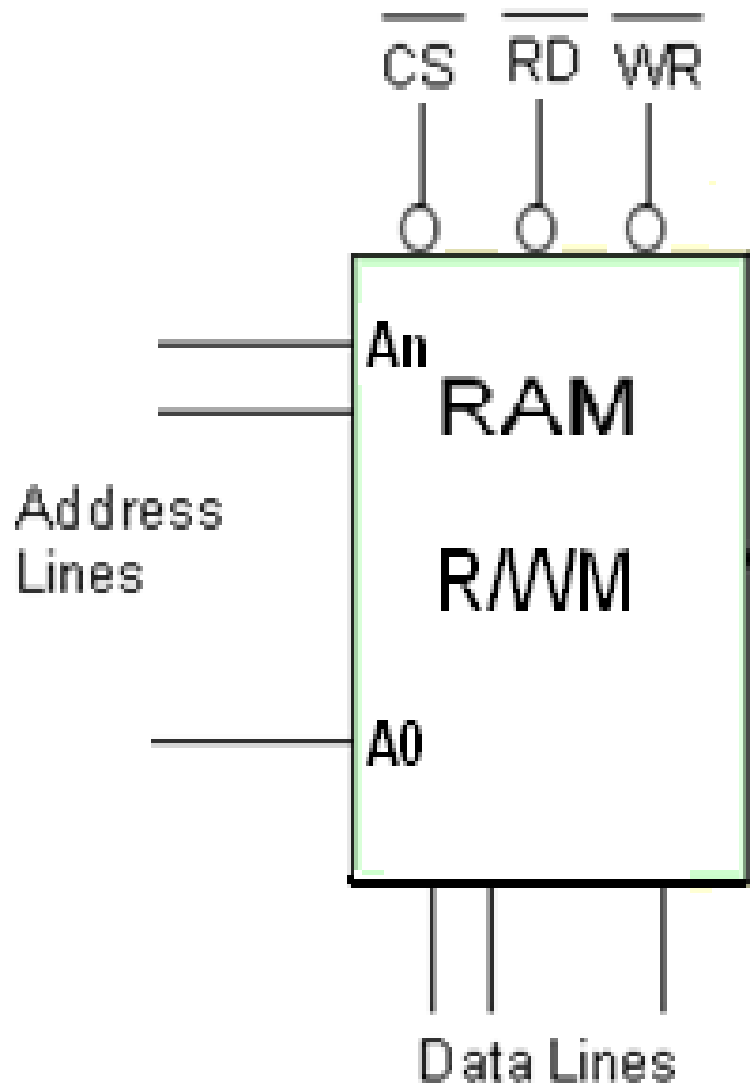
(i) **Address connections** : All memory devices have address inputs that select a memory location within the memory device. Address inputs are labelled from A₀ to A_n.

(ii) **Data connections** : All memory devices have a set of data outputs or input/outputs.

(iii) **Selection connection** : Each memory device has an input that selects or enables the memory device. This kind of input is most often called a chip select (CS), chip enable (CE) or simply select (S) input.

(iv) **Control connections** : A ROM usually has only one control input, while a RAM often has one or two control inputs. The control input most often found on the ROM is the output enable (OE) or gate (G), this allows data to flow out of the output data pins of the ROM. A RAM has two control inputs, they are usually labelled (write enable) or and (output enable) OR read enable

(a) R/W Memory model



(b) ROM Memory model

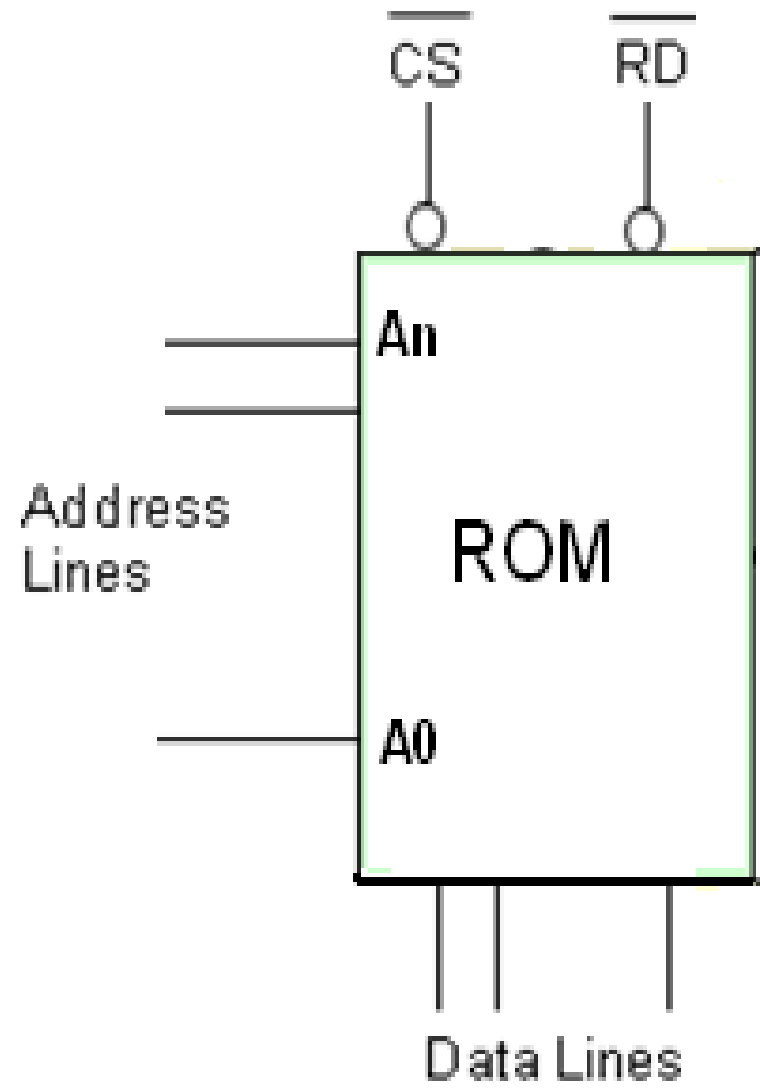


Table 1.2 : Summarizes capacity of memory and required address lines

Memory capacity	Address lines required
1k = 1024 memory locations	10 (A_0 - A_9)
2k = 2048 memory locations	11 (A_0 - A_{10})
4k = 3096 memory locations	12 (A_0 - A_{11})
8k = 8192 memory locations	13 (A_0 - A_{12})
16k = 16384 memory locations	14 (A_0 - A_{13})
32k = 32768 memory locations	15 (A_0 - A_{14})
64k = 65536 memory locations	16 (A_0 - A_{15})

Some of EPROM ICs:

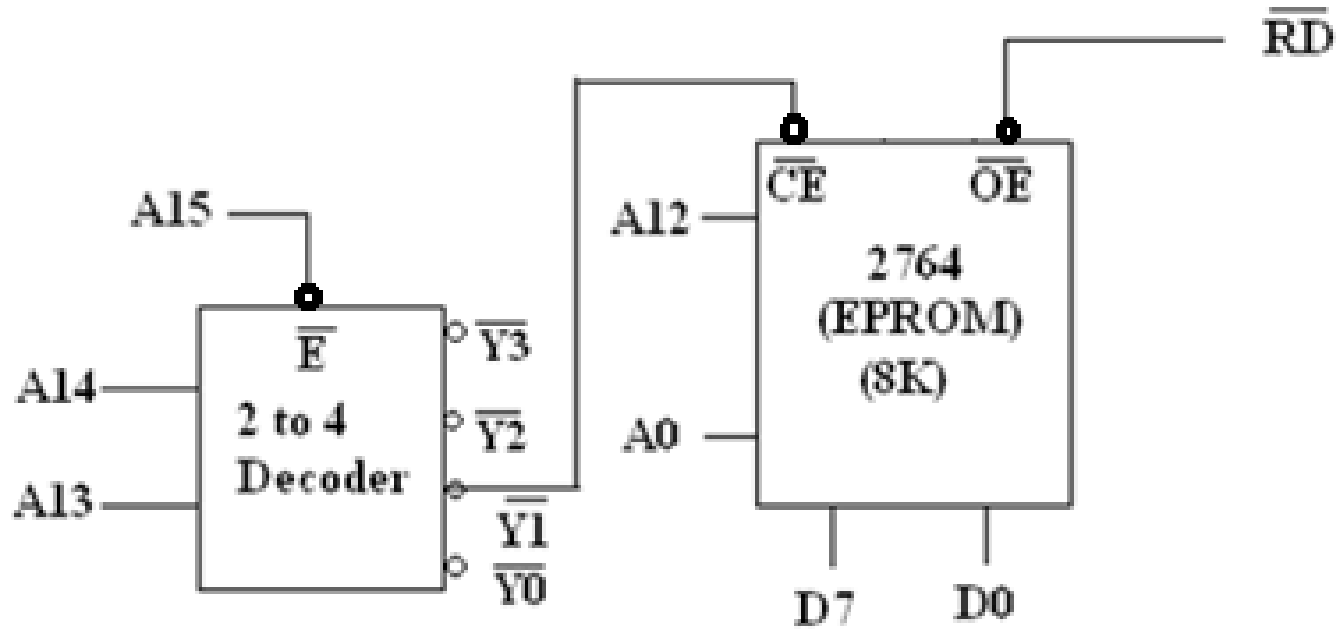
2732 : In this IC 27 indicates it is EPROM and 32 belong to 8 bit data on each location and totally 4k locations
($8 \times 4k = 32$) hence this IC is of 4 kbyte

2764 : In this IC 27 indicates it is EPROM and 64 belong to 8 bit data on each location and totally 8k locations
($8 \times 8k = 64$) hence this IC is of 8 kbyte

27128 : In this IC 27 indicates it is EPROM and 128 belong to 8 bit data on each location and totally 16k locations
($8 \times 16k = 128$) hence this IC is of 16 kbyte.

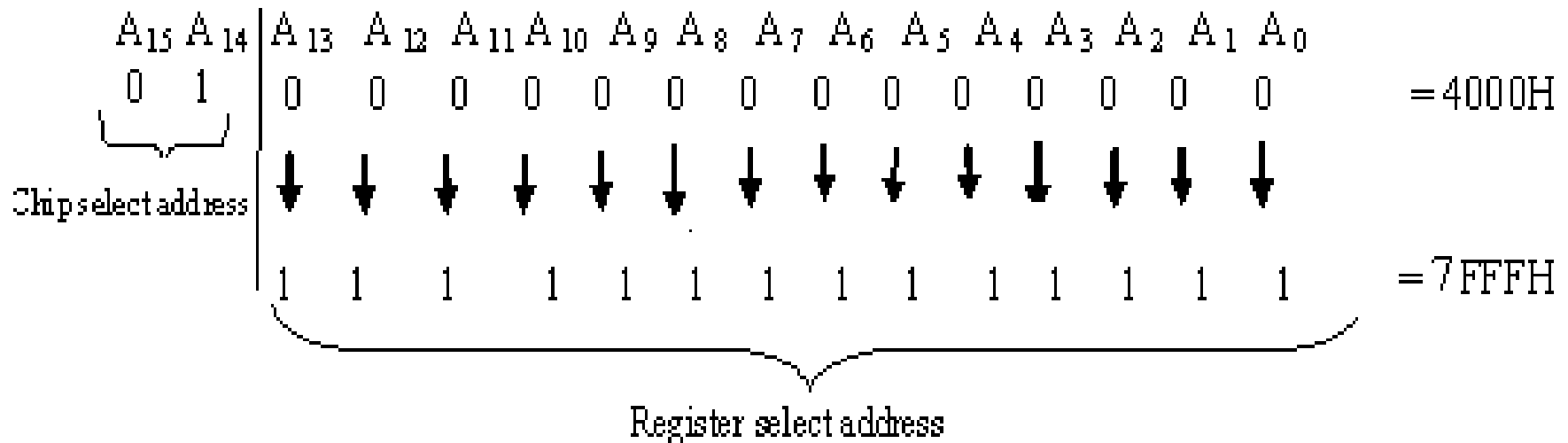
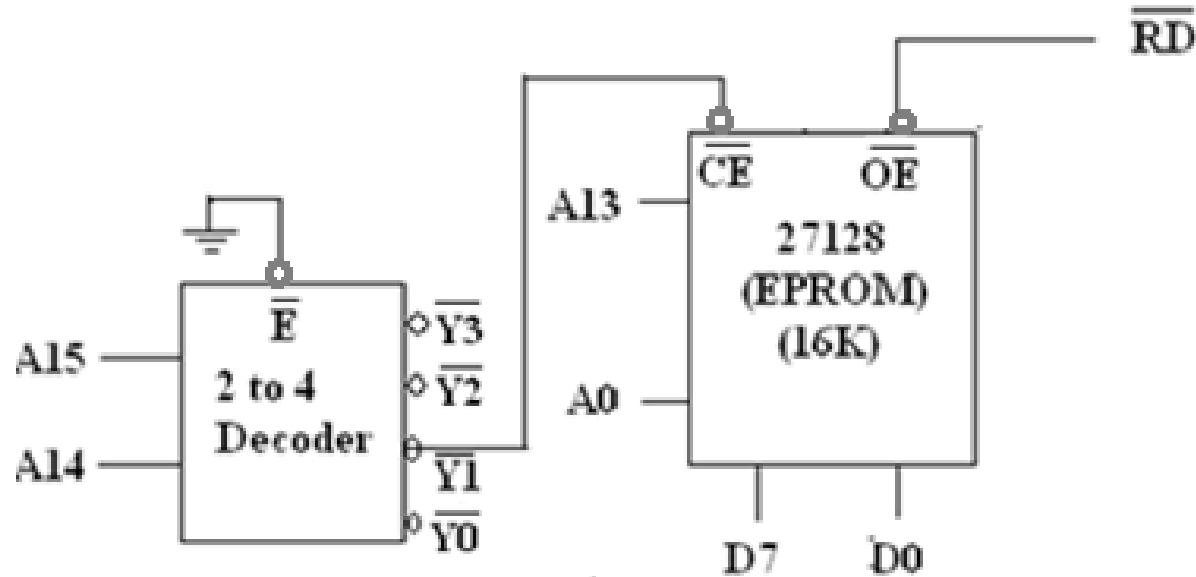
1.2.2.4 EPROM INTERFACING

i) Interfacing EPROM 2764 memory chip



A ₁₅	A ₁₄	A ₁₃	A ₁₂	A ₁₁	A ₁₀	A ₉	A ₈	A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀	
0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	= 2000H
Chip select address			↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	
			1	1	1	1	1	1	1	1	1	1	1	1	1	1
Register select address																

Interfacing of EPROM 27128 memory chip using Decoder IC



1.2.3 Input unit:- This section supplies the data and instructions in binary form to the system. e.g.- keyboard.

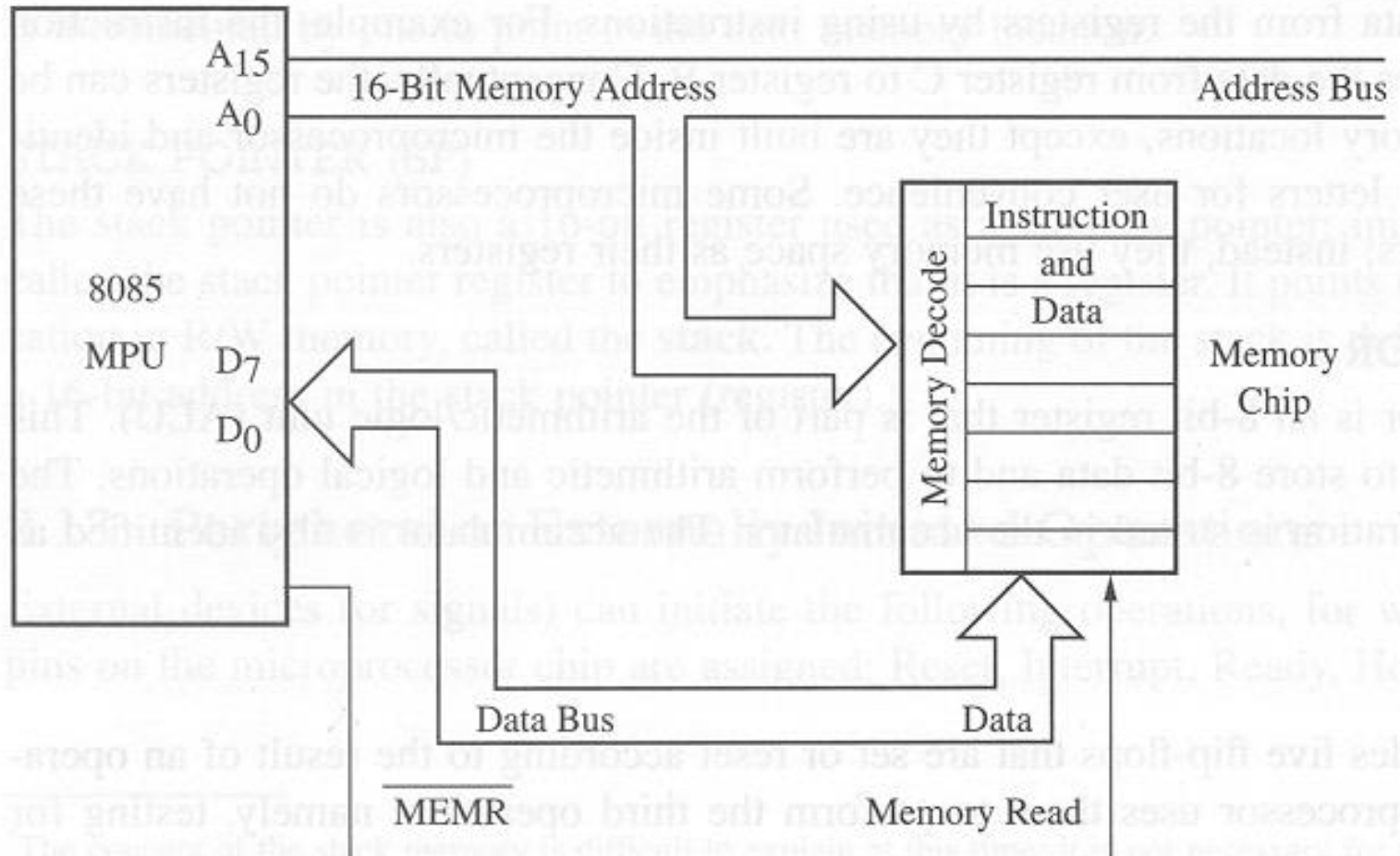
1.2.4. Output Unit:- This section transfers the data from microprocessor to the O/P devices such as 7-segment display, CRT screen, printer etc.

Address Bus:- It is unidirectional bus which carries addresses from microprocessor to peripheral devices.

Data Bus:- It is a bidirectional bus which transfers the data between microprocessor and peripherals.

Control Bus:- Control bus consists of control signals which are given out by control unit of microprocessor to peripheral.

Memory Read Operation



Exercise

Q. Select most correct alternative:

1) Microcomputer system is built using-----

- a) Microprocessor
- b) Memory
- c) Input-Output Devices
- d) all of these

2)is/are the example/s of ROM.

- a) EPROM
- b) MASK
- c) EEPROM
- d) all of these

3) Memory IC 2764 is of -----Byte

- a) 2K
- b) 4K
- c) 8 K
- d) 16 K

4) To interface IC 2764 with 8085, it requires -----address lines.

- a) 11
- b) 12
- c) 13
- d) 14

5) Memory IC 27128 is of -----Byte

- a) 2K
- b) 4K
- c) 8 K
- d) 16 K

6)To interface IC 27128 with 8085, it requires -----address lines.

- a) 11
- b) 12
- c) 13
- d) 14

Q. Long answers questions:

1. Draw a block diagram of Microcomputer system and explain its various parts.
2. What are semiconductor memories? Explain them.
3. Draw the neat schematic showing the interface between 8085 microprocessor and 2764 EPROM. Also explain memory map indicating the address and range.
4. Draw the neat schematic showing the interface between 8085 microprocessor and 27128 EPROM. Also explain memory map indicating the address and range.
5. Interface 27128 EPROM chip to 8085 microprocessor and explain its memory map.
6. How 2764 EPROM chip is interfaced to 8085 microprocessor? Find its memory map.